

SN74ALVC16646 16-BIT BUS TRANSCEIVER AND REGISTER WITH 3-STATE OUTPUTS

SCAS265 - JANUARY 1993 - REVISED MARCH 1994

- Member of the Texas Instruments *Widebus™* Family
- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Designed to Facilitate Incident-Wave Switching for Line Impedances of 50 Ω or Greater
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Bus-Hold On Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 16-bit bus transceiver and register is designed for 2.7-V to 3.6-V V_{CC} operation.

The SN74ALVC16646 can be used as two 8-bit transceivers or one 16-bit transceiver. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the SN74ALVC16646.

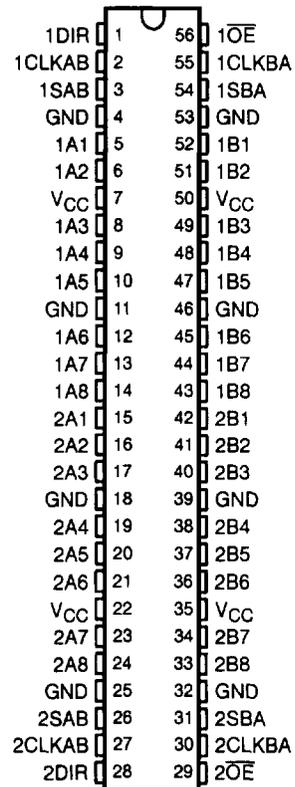
Output-enable (\overline{OE}) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either register or in both. The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. The direction control (DIR) determines which bus receives data when \overline{OE} is low. In the isolation mode (\overline{OE} high), A data may be stored in one register and/or B data may be stored in the other register.

When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

The SN74ALVC16646 is available in TI's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN74ALVC16646 is characterized for operation from -40°C to 85°C .

DGG OR DL PACKAGE
(TOP VIEW)



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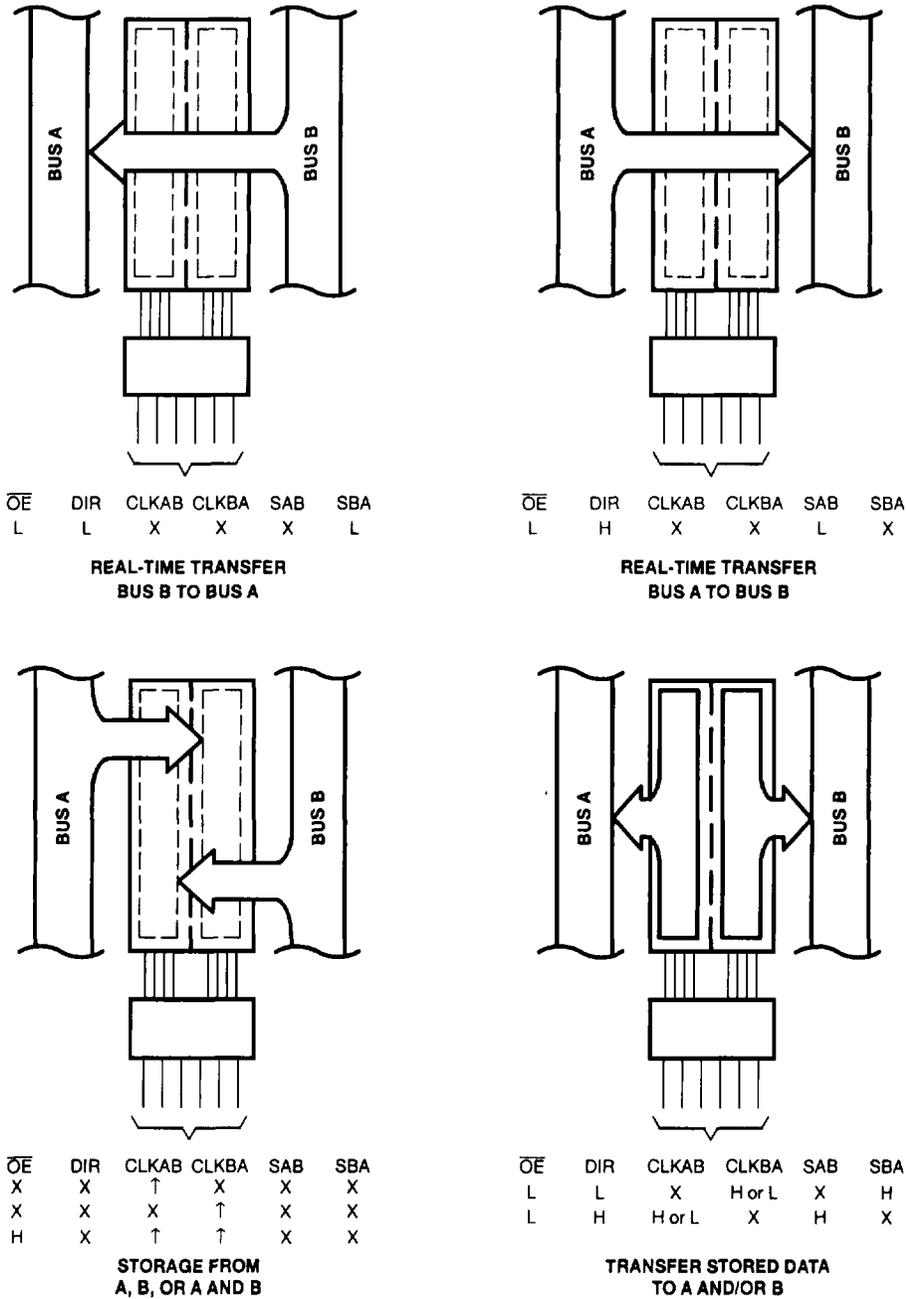


Figure 1. Bus-Management Functions

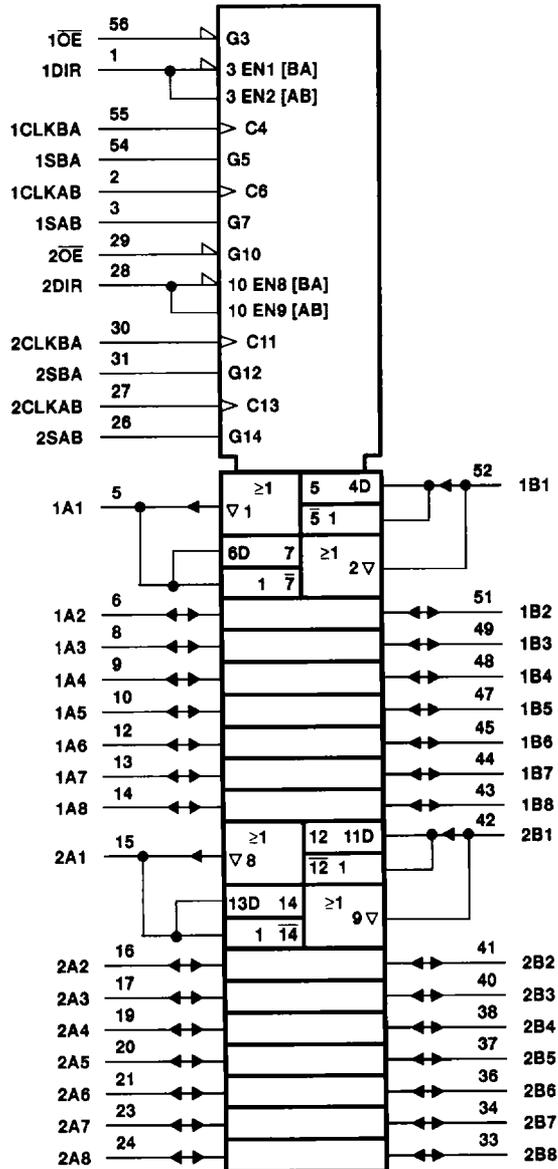


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logic symbol†



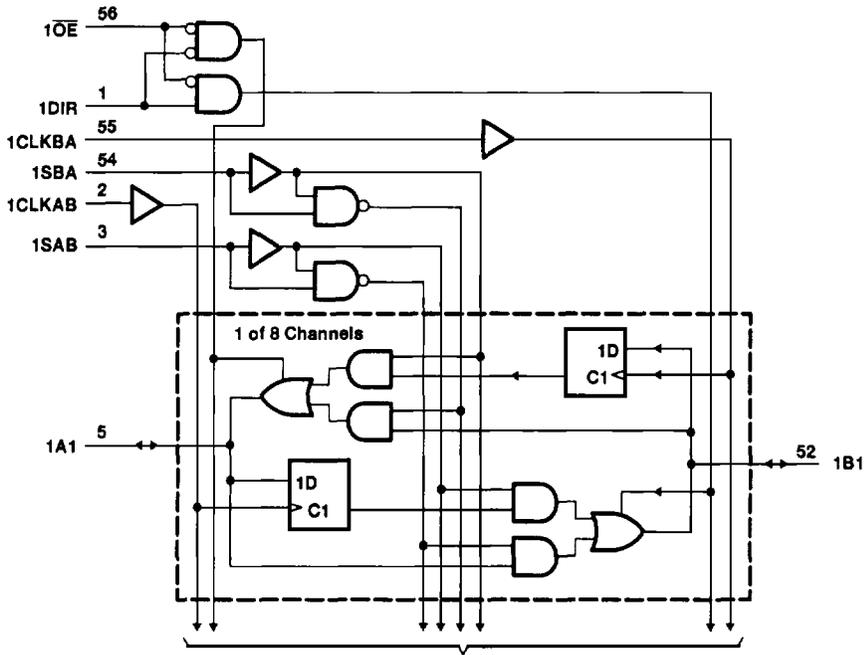
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



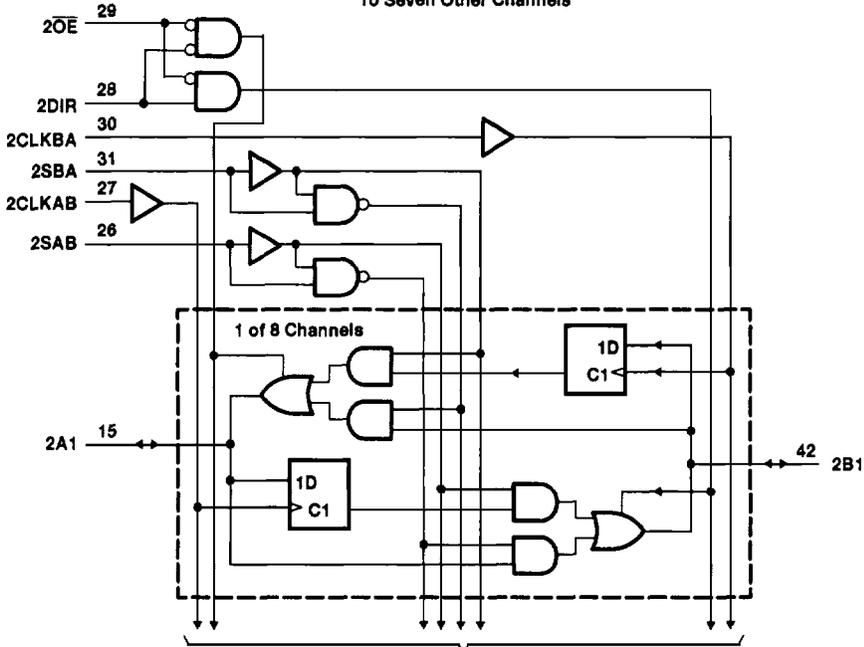
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logic diagram (positive logic)



To Seven Other Channels



To Seven Other Channels

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FUNCTION TABLE

| INPUTS | | | | | | DATA I/Os | | OPERATION OR FUNCTION |
|--------|-----|--------|--------|-----|-----|----------------|----------------|---------------------------|
| OE | DIR | CLKAB | CLKBA | SAB | SBA | A1 THRU A8 | B1 THRU B8 | |
| X | X | ↑ | X | X | X | Input | Unspecified† | Store A, B unspecified† |
| X | X | X | ↑ | X | X | Unspecified† | Input | Store B, A unspecified† |
| H | X | ↑ | ↑ | X | X | Input | Input | Store A and B data |
| H | X | H or L | H or L | X | X | Input disabled | Input disabled | Isolation, hold storage |
| L | L | X | X | X | L | Output | Input | Real-time B data to A bus |
| L | L | X | H or L | X | H | Output | Input | Stored B data to A bus |
| L | H | X | X | L | X | Input | Output | Real-time A data to B bus |
| L | H | H or L | X | H | X | Input | Output | Stored A data to B bus |

† The data output functions may be enabled or disabled by various signals at the OE and DIR inputs. Data input functions are always enabled; i.e., data at the bus pins will be stored on every low-to-high transition of the clock inputs.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| | |
|--|----------------------------|
| Supply voltage range, V_{CC} | -0.5 V to 4.6 V |
| Input voltage range, V_I (except I/O ports) (see Note 1) | -0.5 V to 4.6 V |
| Input voltage range, V_I (I/O ports) (see Notes 1 and 2) | -0.5 V to $V_{CC} + 0.5$ V |
| Output voltage range, V_O (see Notes 1 and 2) | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | -50 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ±50 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±50 mA |
| Continuous current through V_{CC} or GND | ±100 mA |
| Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 3): DGG package | 1 W |
| DL package | 1.4 W |
| Storage temperature range | -65°C to 150°C |

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. This value is limited to 4.6 V maximum.
 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note.

recommended operating conditions

| | | MIN | MAX | UNIT |
|---------------------|------------------------------------|---------------------------|----------|------|
| V_{CC} | Supply voltage | 2.7 | 3.6 | V |
| V_{IH} | High-level input voltage | $V_{CC} = 2.7$ V to 3.6 V | | V |
| V_{IL} | Low-level input voltage | $V_{CC} = 2.7$ V to 3.6 V | | V |
| V_I | Input voltage | 0 | V_{CC} | V |
| V_O | Output voltage | 0 | V_{CC} | V |
| I_{OH} | High-level output current | $V_{CC} = 2.7$ V | | mA |
| | | $V_{CC} = 3$ V | | |
| I_{OL} | Low-level output current | $V_{CC} = 2.7$ V | | mA |
| | | $V_{CC} = 3$ V | | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | 0 | 10 | ns/V |
| T_A | Operating free-air temperature | -40 | 85 | °C |



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | V _{CC} † | MIN | MAX | UNIT |
|-----------------------|----------------|---|-------------------|----------------------|-----|------|
| V _{OH} | | I _{OH} = -100 µA | MIN to MAX | V _{CC} -0.2 | | V |
| | | I _{OH} = -12 mA | 2.7 V | 2.2 | | |
| | | I _{OH} = -24 mA | 3 V | 2.4 | | |
| | | I _{OH} = -24 mA | 3 V | 2 | | |
| V _{OL} | | I _{OL} = 100 µA | MIN to MAX | 0.2 | | V |
| | | I _{OL} = 12 mA | 2.7 V | 0.4 | | |
| | | I _{OL} = 24 mA | 3 V | 0.55 | | |
| I _I | | V _I = V _{CC} or GND | 3.6 V | ±5 | | µA |
| I _I (hold) | Data I/Os | V _I = 0.8 V | 3 V | 75 | | µA |
| | | V _I = 2 V | | -75 | | |
| I _{OZ} ‡ | | V _O = V _{CC} or GND | 3.6 V | ±10 | | µA |
| I _{CC} | | V _I = V _{CC} or GND, I _O = 0 | 3.6 V | 40 | | µA |
| ΔI _{CC} | | V _{CC} = 3 V to 3.6 V, One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND | | 750 | | µA |
| C _i | Control inputs | V _I = V _{CC} or GND | 3.3 V | | | pF |
| C _{io} | A or B ports | V _O = V _{CC} or GND | 3.3 V | | | pF |

† For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.

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